

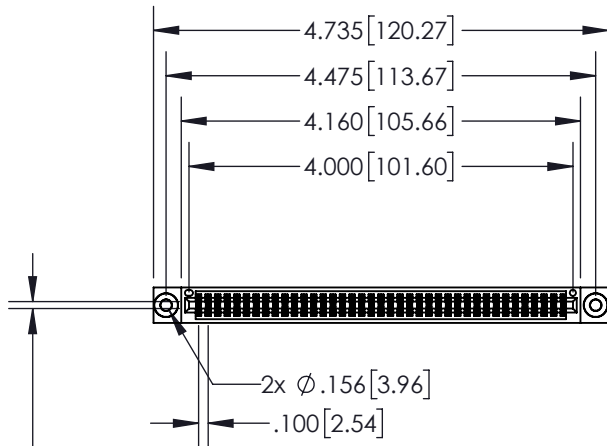
Contact Dimensions:
560-Extender Board Bend (Code 523 Contacts)
 See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

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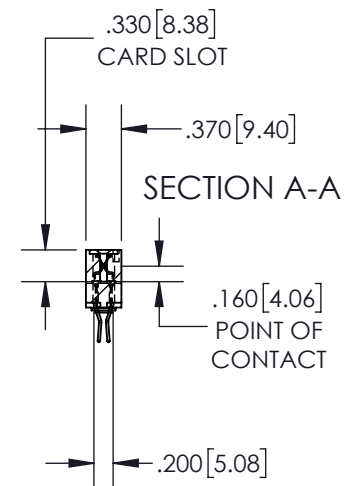
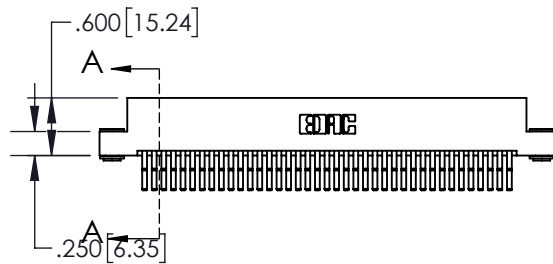


ISSUE NUMBER

ORIGINAL



CARD SLOT ACCEPTS
 .054" [1.37] TO .070" [1.78]
 THICK PCB



- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL: COPPER TIN ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR
 PART NUMBER: 895-078-560-203

ACAD REFERENCE NO. 845-ENG-MASTER

DRAWN: R.STA.MONICA DATE: MAY.16/2017

CHECKED: DATE:

SCALE: 1:2 SHEET 1 OF 2

DRAWING NUMBER 845-ENG-MASTER ISSUE 1

EDAC EDAC INC
 TORONTO, ONTARIO
 CANADA
 YOUR CONNECTION TO QUALITY & SERVICE

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ISSUE NUMBER

ORIGINAL



Contact Code 555



Contact Code 556



Contact Code 558



Contact Code 559



Contact Code 560

- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0
- DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL: COPPER ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

**845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR
CONTACT CODE 555,556,558,559,560 DIMENSIONS**



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ACAD REFERENCE NO. 845-ENG-MASTER	
DRAWN: R.STA.MONICA	DATE: MAY.16/2017
CHECKED:	DATE:
SCALE: 1:1	SHEET 2 OF 2
DRAWING NUMBER 845-ENG-MASTER	ISSUE 1